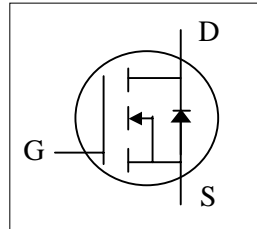


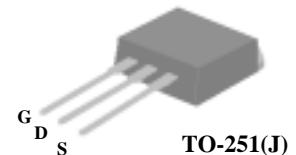
- ▼ Low Gate Charge
- ▼ Simple Drive Requirement
- ▼ Fast Switching



BV_{DSS}	25V
$R_{DS(ON)}$	50m Ω
I_D	16A

Description

The TO-252 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters. The through-hole version (AP3302J) is available for low-profile applications.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	25	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, V_{GS} @ 10V	16	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, V_{GS} @ 10V	10	A
I_{DM}	Pulsed Drain Current ¹	25	A
$P_D@T_C=25^\circ C$	Total Power Dissipation	20	W
	Linear Derating Factor	0.16	W/ $^\circ C$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal Resistance Junction-case	Max. 6.4	$^\circ C/W$
Rthj-amb	Thermal Resistance Junction-ambient	Max. 110	$^\circ C/W$



AP3302H/J

Electrical Characteristics @T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	25	-	-	V
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =8A	-	-	50	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	2	-	4	V
I _{DSS}	Drain-Source Leakage Current (T _j =25°C)	V _{DS} =25V, V _{GS} =0V	-	-	1	uA
	Drain-Source Leakage Current (T _j =150°C)	V _{DS} =20V, V _{GS} =0V	-	-	25	uA
I _{GSS}	Gate-Source Leakage	V _{GS} = ± 20V	-	-	±100	nA
Q _g	Total Gate Charge ²	I _D =10A	-	7.4	13	nC
Q _{gs}	Gate-Source Charge	V _{DS} = 24V	-	2.2	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =10V	-	4.2	-	nC
t _{d(on)}	Turn-on Delay Time ²	V _{DS} =15V	-	8	-	ns
t _r	Rise Time	I _D =16A	-	7.4	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =3.3Ω, V _{GS} =10V	-	11	-	ns
t _f	Fall Time	R _D =0.94Ω	-	3	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	164	290	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	158	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	62	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ²	I _S =16A, V _{GS} =0V	-	-	1.3	V
t _{rr}	Reverse Recovery Time	I _S =16A, V _{GS} =0V,	-	29	-	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	21	-	nC

Notes:

- 1.Pulse width limited by safe operating area.
- 2.Pulse width ≤300us , duty cycle ≤2%.

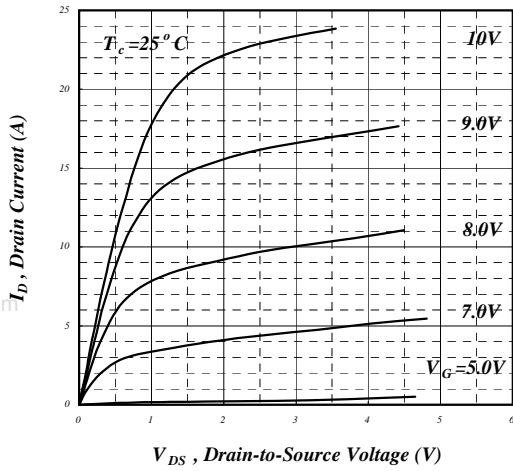


Fig 1. Typical Output Characteristics

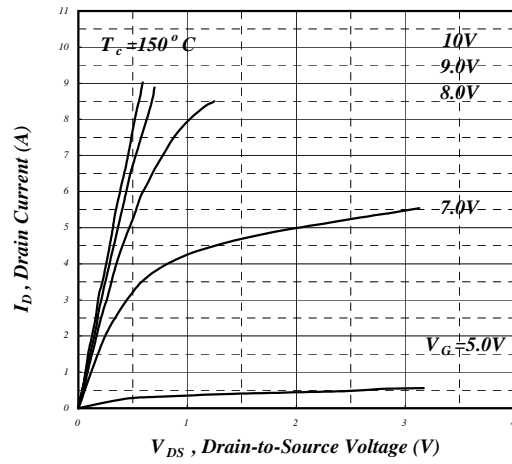


Fig 2. Typical Output Characteristics

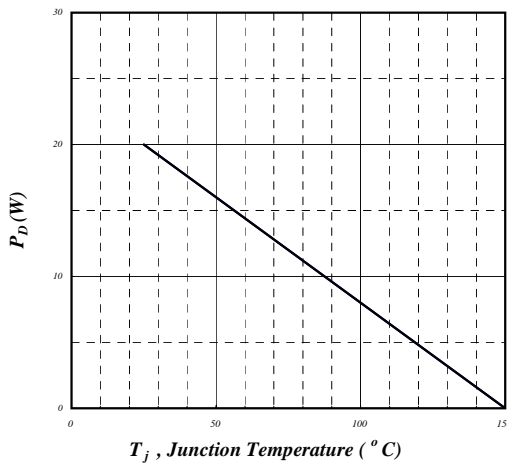


Fig 3. On-Resistance v.s. Gate Voltage

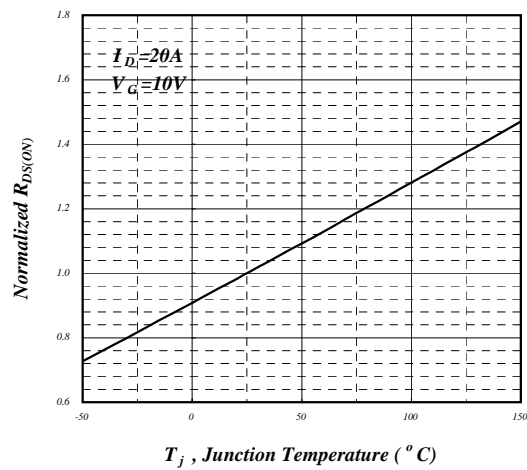


Fig 4. Normalized On-Resistance v.s. Junction Temperature

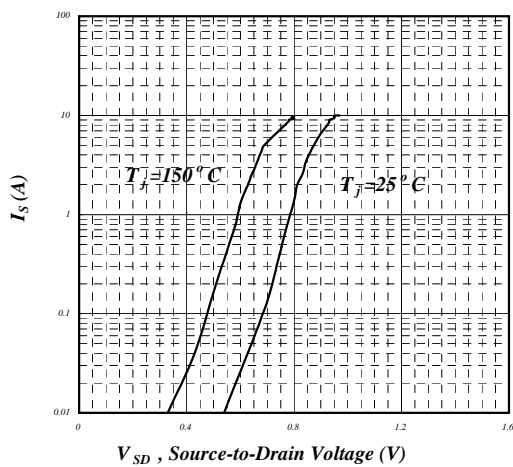


Fig 5. Forward Characteristic of Reverse Diode

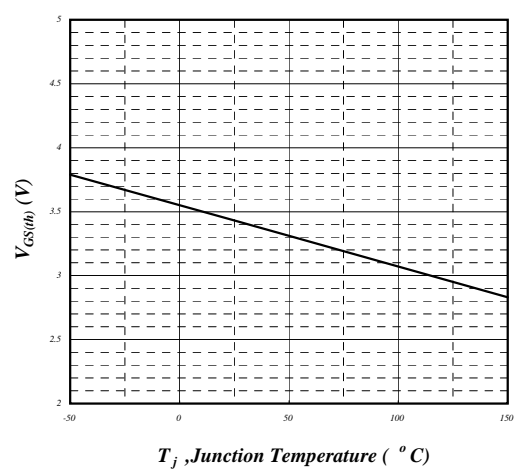


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

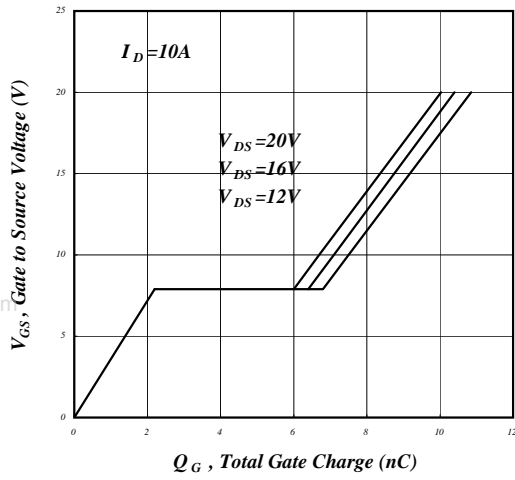


Fig 7. Gate Charge Characteristics

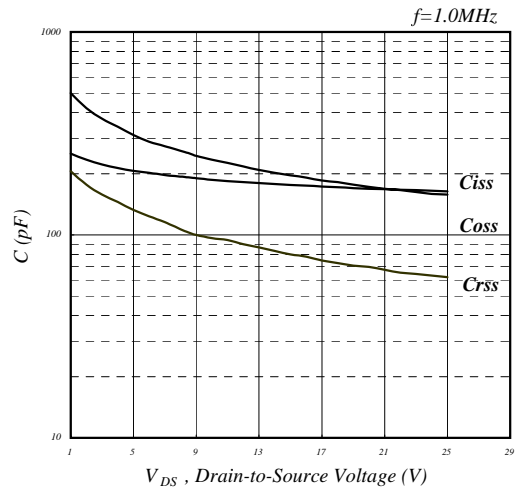


Fig 8. Typical Capacitance Characteristics

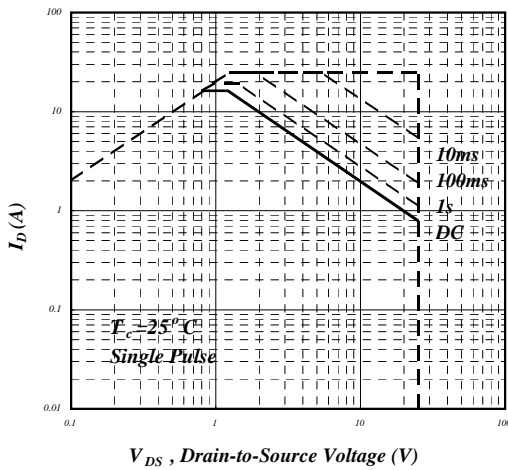


Fig 9. Maximum Safe Operating Area

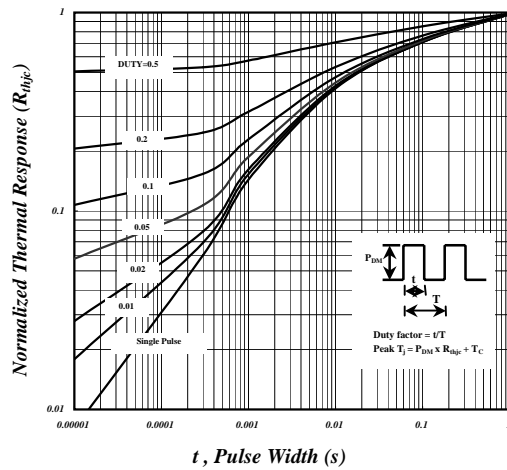


Fig 10. Effective Transient Thermal Impedance

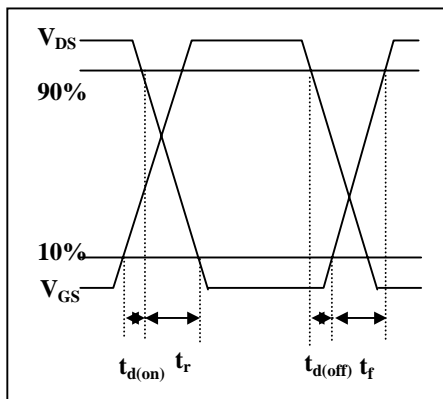


Fig 11. Switching Time Waveform

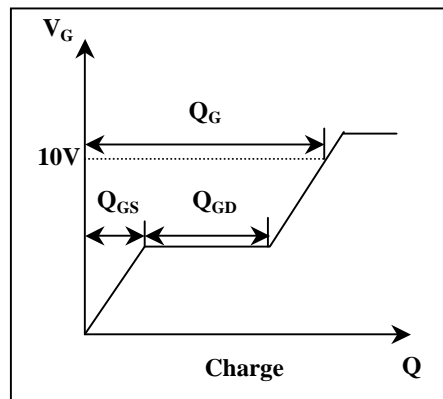


Fig 12. Gate Charge Waveform